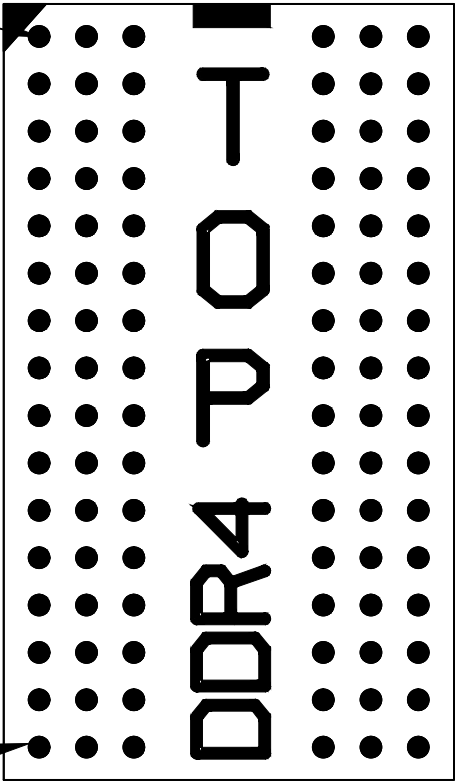


REVISIONS				
ECO #	REV	DESCRIPTION	DATE	APPROVED
C01315	A	NEW RELEASE	2/5/14	SCOTT R.

NOTES:

- 1. ASSEMBLE TO IPC610 CLASS 2.
- 2. REFER TO BOM FOR COMPLETE LIST OF POPULATION OPTIONS
- 3. USE LEAD-FREE SOLDER PROCESS
- 4. HANDLE ONLY WITH ESD PROTECTION
- 5. NO SOLDER ON BGA PADS
- 6. APPLY BGA BALLS, BOTTOM SIDE, TIN/LEAD OR UNLEADED PER PURCHASE ORDER.

PIN A1



TOP VIEW

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UNLESS OTHERWISE SPECIFIED:
DIMENSIONS ARE IN INCHES
[MILLIMETERS BRACKETED FOR REF.]
TOLERANCES
DECIMALS .XX ± .010" ANGULAR FRACTIONAL .XXX ± .004" ± 1' ± 1/16"

MAT'L. SEE NOTES

DO NOT SCALE DRAWING

DRAWN ANTERO G.

CHECKED SCOTT R.

Astek

5055 CORPORATE PLAZA DRIVE
Colorado Springs, CO 80919 U.S.A.
Ph: 719.260.1625 www.astekcorp.com

DATE 2/5/14

DWG NAME DDR4X16_RISER_ASSEMBLY_DRAWING

DATE 2/5/14

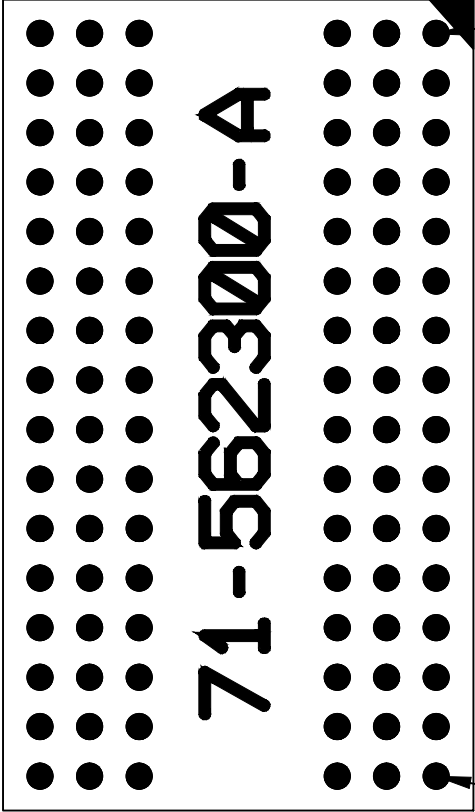
SCALE N/A

B

DWG NO. 71-562600

SHEET 1 OF 2

REV A



PIN A1

6

BOTTOM VIEW

DWG NAME	DDR4X16_RISER_ASSEMBLY_DRAWING			
SCALE	N/A	B	DWG NO. 71-562600	SHEET 2 OF 2
			REV	A